



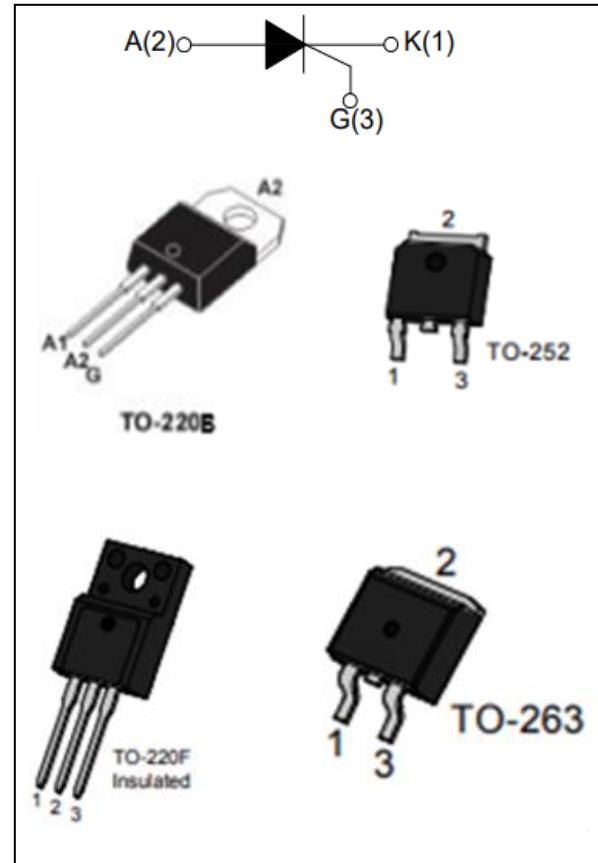
## ● Feature and Application

### Features:

- Single side grooving technology with independent intellectual property rights, table glass passivation technology;
- Multi-layer metallized electrode;
- High blocking voltage and high temperature stability

### Applications:

Vacuum cleaners, power tools and other motor speed controllers; Solid state relays; Heating controllers (temperature regulation); And other phase control circuits.



## ● Characteristics

**Table 1. Absolute maximum ratings ( $T_{VJ} = 25^\circ\text{C}$  unless otherwise stated)**

Symbol	Parameter and test conditions			value	Unit
$I_{T(AV)}$	On state average current	$T_c=125^\circ\text{C}$	$T_{VJ}=150^\circ\text{C}$	13	A
$I_{T(RMS)}$	RMS on-state current (full sine wave)	$T_c=105^\circ\text{C}$		20	A
$I_{TSM}$	Non repetitive surge peak on-state current (full cycle, $T_{VJ}$ initial = $25^\circ\text{C}$ )	$F=50\text{Hz}$	$t=10\text{ms}$	200	A



I <sup>2</sup> t	I <sup>2</sup> t value for fusing	t <sub>p</sub> =10ms f=50HZ	T <sub>VJ</sub> =45°C	144	A <sup>2</sup> S
(di/dt) cr	Critical rate of rise of on-state current I <sub>G</sub> = 2 x I <sub>GT</sub> , t <sub>r</sub> ≤ 100 ns		T <sub>VJ</sub> =150°C;f=50Hz	50	A/us
V <sub>RRM/DRM</sub>	max. repetitive reverse/forward blocking voltage		T <sub>VJ</sub> =25°C	600 800	V
I <sub>GM</sub>	Peak gate current	t <sub>p</sub> =20us T <sub>VJ</sub> =125°C		4	A
P <sub>G(AV)</sub>	Average gate power dissipation		T <sub>C</sub> =150°C	1	W
T <sub>stg</sub> T <sub>VJ</sub>	Storage junction temperature range Operating junction temperature range			-40to+150 -40to+125	°C

**Table 2. Dynamic electrical characteristics (T<sub>VJ</sub>=25°C, unless otherwise specified)**

Symbol	Parameter and test conditions		value	Unit
I <sub>GT</sub>	V <sub>D</sub> =12V R <sub>L</sub> =100 Ω	MAX	15	mA
V <sub>GT</sub>		MAX	1.5	V
V <sub>GD</sub>	V <sub>D</sub> =2/3 V <sub>DRM</sub> T <sub>VJ</sub> = 150°C	MAX	0.2	V
I <sub>GD</sub>		MAX	3	mA
I <sub>H</sub>	V <sub>D</sub> = 12V R <sub>GK</sub> = ∞ T <sub>VJ</sub> = 25°C	MAX	30	mA
I <sub>L</sub>	t <sub>p</sub> =10us I <sub>G</sub> =0,3A; di <sub>G</sub> /dt =0,3A/μs; T <sub>VJ</sub> = 25°C	MAX	40	mA
t <sub>gd</sub>	V <sub>D</sub> =1/2 V <sub>DRM</sub> T <sub>VJ</sub> =25°C I <sub>G</sub> =0,3A; di <sub>G</sub> /dt =0,3A/μs	MAX	2	us
t <sub>q</sub>	V <sub>R</sub> =100V I <sub>T</sub> =80A V=2/3V <sub>DRM</sub> T <sub>VJ</sub> =125°C di/dt=20A/us dv/dt=20V/us tp=200us	Typ	200	us
(dv/dt) cr	V <sub>D</sub> =2/3V <sub>DRM</sub> R <sub>GK</sub> = ∞ T <sub>VJ</sub> =150°C	MAX	200	V/us



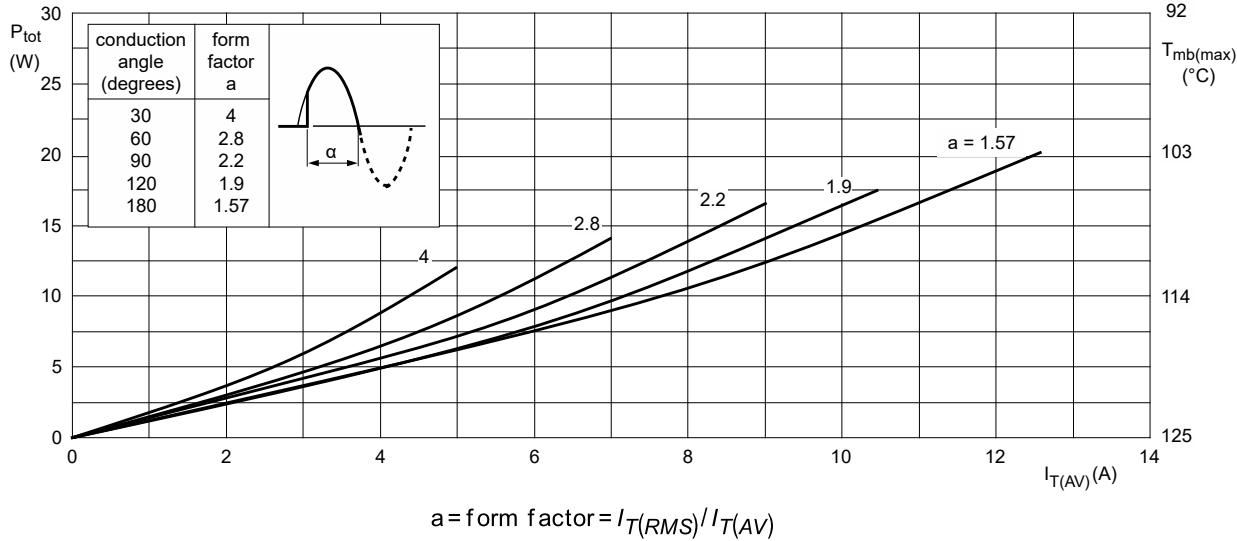
**Table 3. Static electrical characteristics**

Symbol	Parameter and test conditions			value	Unit
V <sub>TM</sub>	I <sub>TM</sub> =36A	T <sub>VJ</sub> =25°C	MAX	1.70	V
V <sub>T0</sub>	Threshold on-state voltage	T <sub>VJ</sub> =150°C	MAX	0.86	V
R <sub>d</sub>	Dynamic resistance	T <sub>VJ</sub> =125°C	MAX	36.6	mΩ
I <sub>R/D</sub>	V <sub>R/D</sub> =800V V <sub>R/D</sub> =800V	T <sub>VJ</sub> =25°C	MAX	5	uA
		T <sub>VJ</sub> =125°C		1	mA
R <sub>th(j-c)</sub>	Junction to ambient			1.75	°C/W

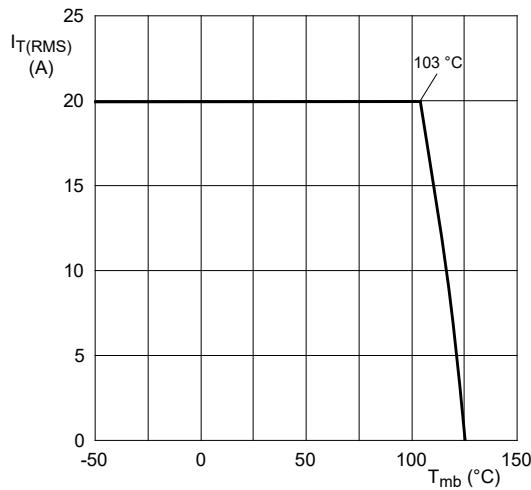


## Typical Characteristic Curves:

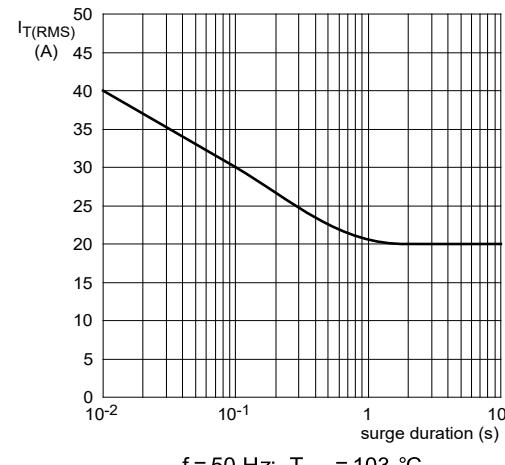
**Fig. 1. Total power dissipation as a function of average on-state current; maximum values**



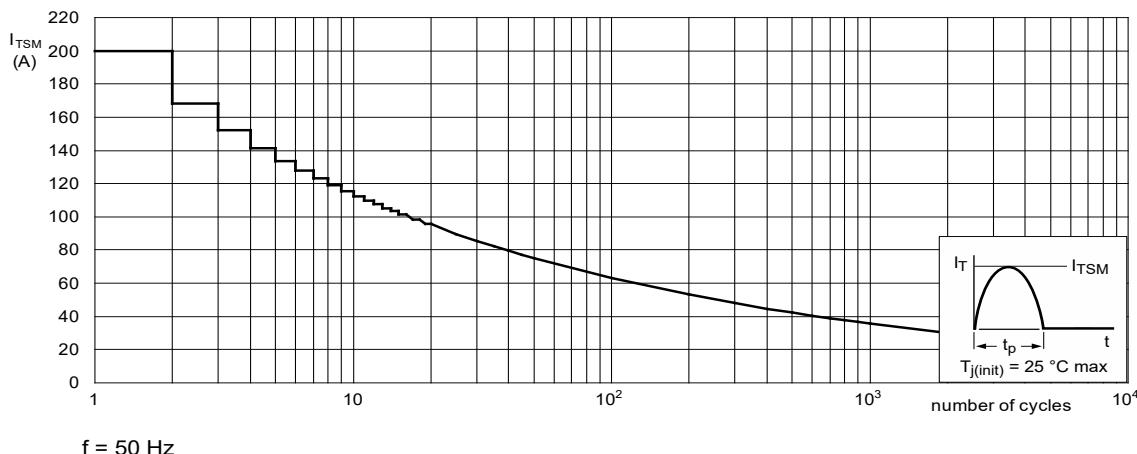
**Fig. 2. RMS on-state current as a function of mounting base temperature; maximum values**



**Fig. 3. RMS on-state current as a function of surge duration; maximum values**



**Fig. 4. Non-repetitive peak on-state current as a function of the number of sinusoidal current cycles; maximum values**





## Typical Characteristic Curves:

Fig. 5. Non-repetitive peak on-state current as a function of pulse width for sinusoidal currents; maximum values

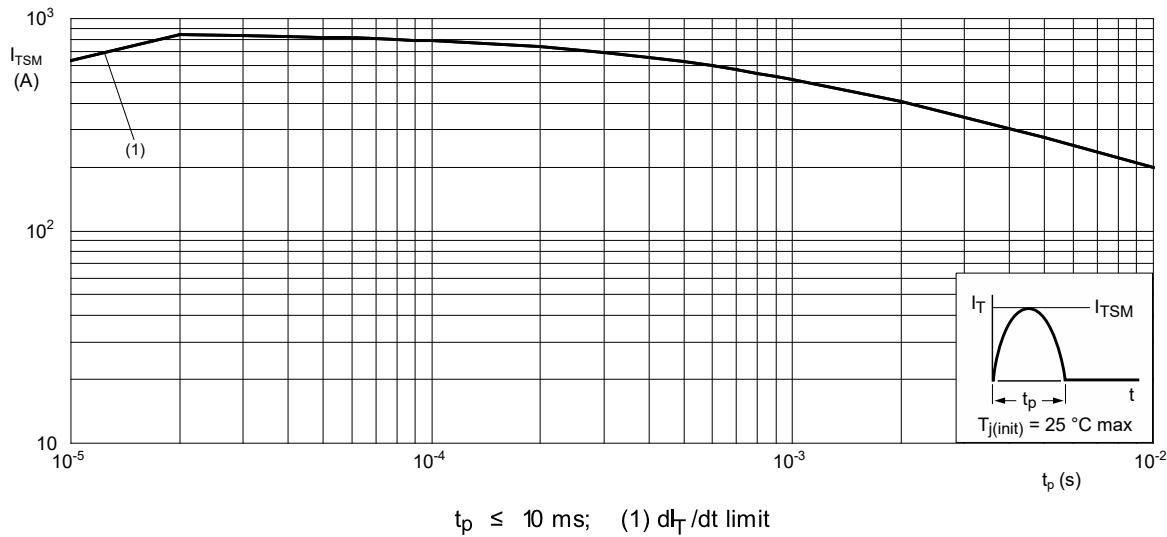


Fig. 6. Normalized gate trigger current as a function of junction temperature

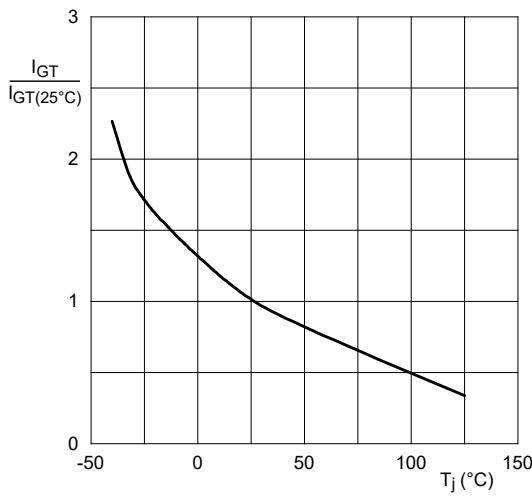
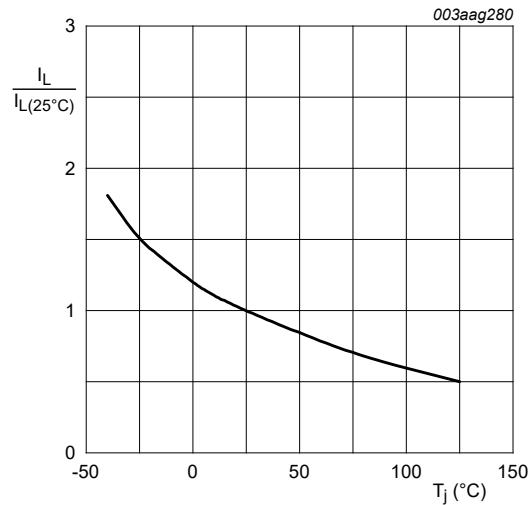


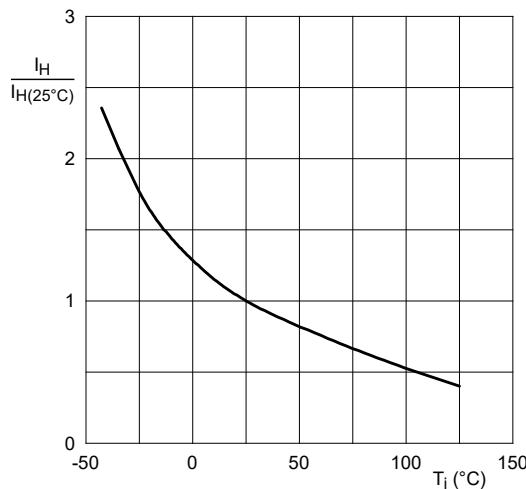
Fig. 7. Normalized latching current as a function of junction temperature



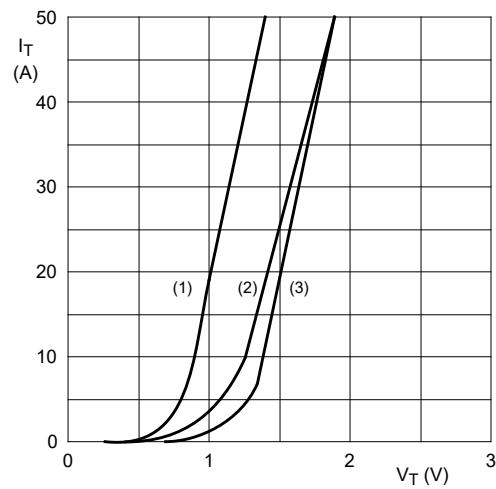


## Typical Characteristic Curves:

**Fig. 8. Normalized holding current as a function of junction temperature**



**Fig. 9. On-state current as a function of on-state voltage**



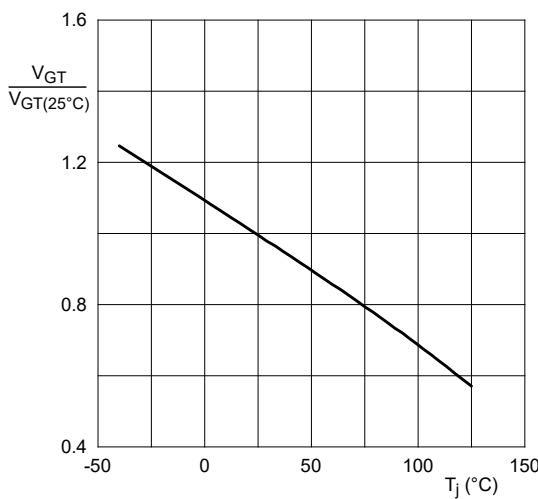
$V_o = 1.06 \text{ V}$ ;  $R_s = 0.03 \Omega$

(1)  $T_j = 125 \text{ }^{\circ}\text{C}$ ; typical values

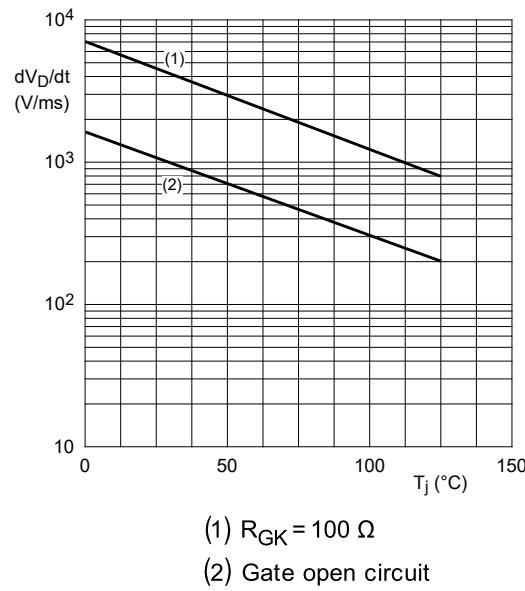
(2)  $T_j = 125 \text{ }^{\circ}\text{C}$ ; maximum values

(3)  $T_j = 25 \text{ }^{\circ}\text{C}$ ; maximum values

**Fig. 10. Normalized gate trigger voltage as a function of junction temperature**



**Fig. 11. Critical rate of rise of off-state voltage as a function of junction temperature; typical values**



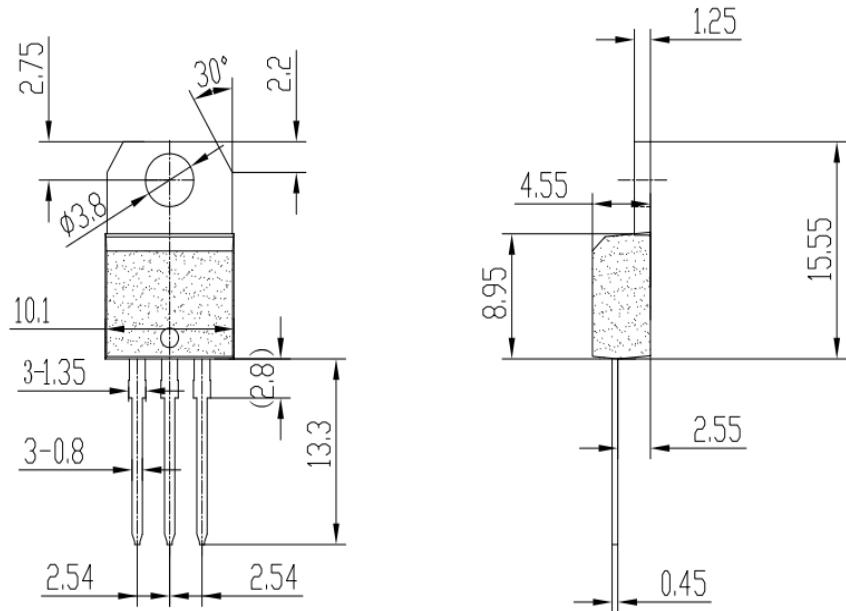
(1)  $R_{GK} = 100 \Omega$

(2) Gate open circuit



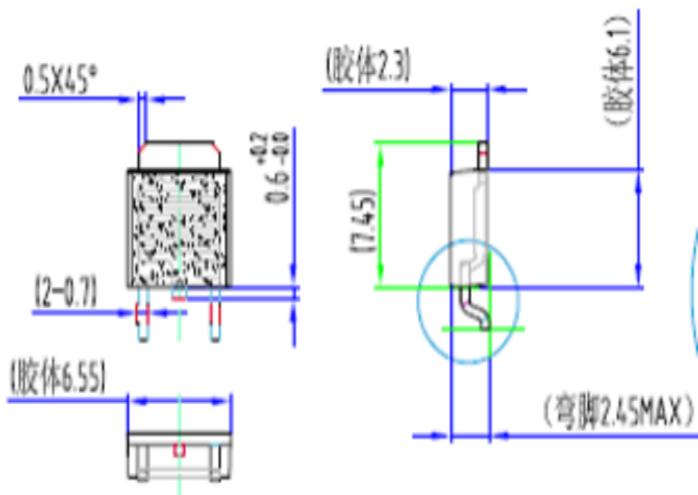
● TO-220 Dimensional drawing:

Unit: mm ( $\pm 0.1$ )



● TO-252 Dimensional drawing:

Unit: mm ( $\pm 0.1$ )





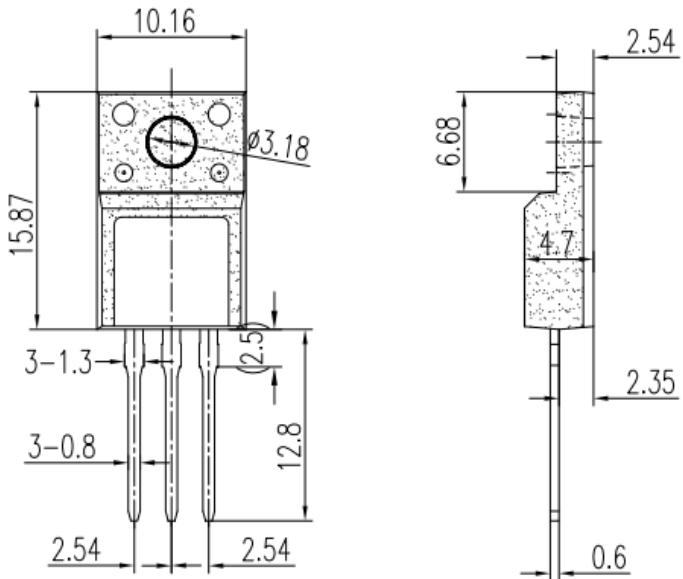
# **BT152**

## **Silicon Control Rectifiers**



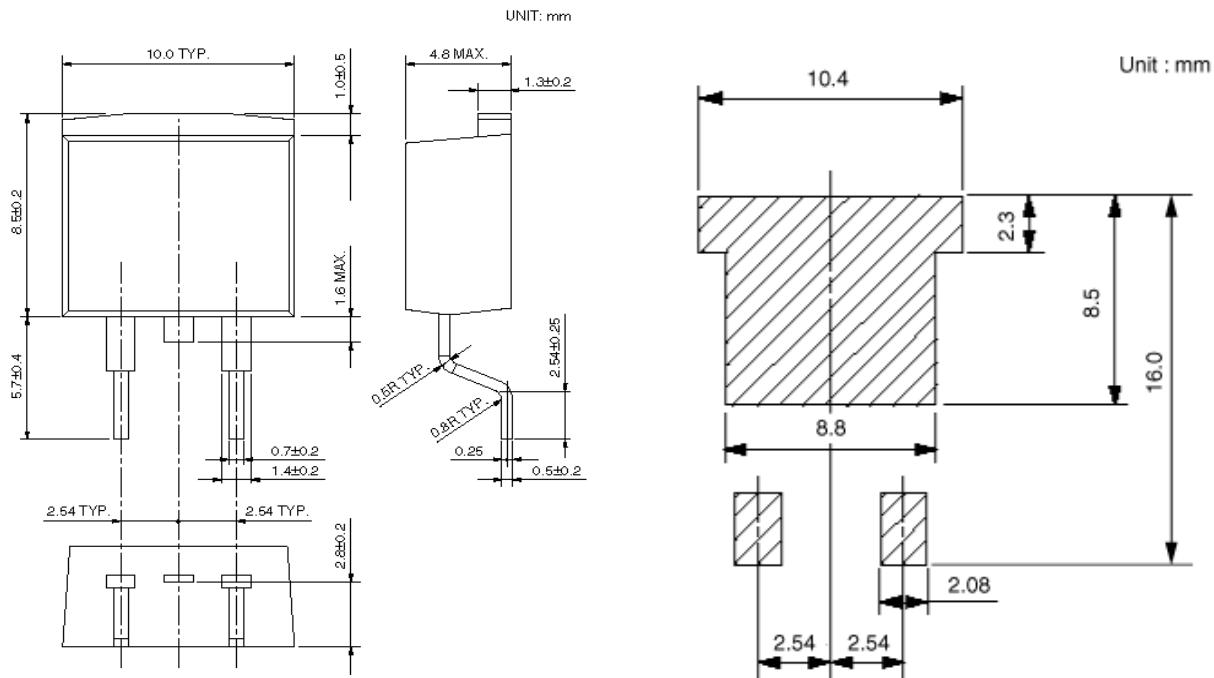
### ● TO-220F Dimensional drawing:

Unit: mm ( $\pm 0.1$ )



## ● TO-263 Dimensional drawing:

Unit: mm ( $\pm 0.1$ )



: The area without solder plated